

Digital Controller COMPACT CONTROLLER M [CC-M] (PROGRAMMABLE CONTINUOUS OUTPUT TYPE)

DATA SHEET PDA3

The Compact Controller M (programmable continuous output type) is a multi-loop process controller.

It accepts 1 to 5 V DC and signals from thermocouples and resistance bulb as input, and is provided with abundant control and computation functions to allow configuring a flexible system with a high cost performance.

FEATURES

1. Multi-loop controller of up to 4 control outputs.

CC-M has max.4 control outputs, that is real 4-loop multi-loop controller.

[Note] In this data sheet, the term "loop" is used in the same meaning as the quantity of control output.

2. Control and computation functions dependent on wafers Control and computation functions are implemented by combining function-software packages called "WAFERS." Since the WAFERS are built in the controller, optimum system can be programmed by using the front-panel keys and the PC based configurator.

3. High visibility ensured with color graphic display

A color LCD is adopted for graphic display of multi-loop bar graph and trend screens, etc.

4. Communication function (option)

RS-485 (Modbus $^{\circledR}$ protocol or OPTO22 interface $^{\circledR}$) are available.

5. Soft logic function (option)

PLC function can be implemented by IEC61131-3 standard programming language through the PC based configuration software.

6. Back-up (option)

If the controller becomes faulty, influence over the system can be evaded by changing the built-in backup operation unit.

7. Memory card (option)

Memory card can save any data, for example process input, WAFER output, etc.

SPECIFICATIONS

1. Control and Computation Functions

Control and computation functions are implemented by combining function-software packages called "WAFERS." Combination of WAFERS is called "WAFER connection." CC-M comprises 100 kinds of WAFERS.

WAFER connection is made by operating the keys on the front panel or using the PC based configurator.



(1) PID control

Number of loops and PID

: Selectable among the following 1 loop (1 control output / 2PID) 2 loops (2 control outputs / 4PID) 4 loops (4 control outputs / 8PID)

Proportional band (P)

: 1.0 to 3276.7%, set at 3000.0% for delivery

· Integration time (I)

: 0.1 to 3276.7 s, set at 3000.0 s for delivery

• Derivative time (D)

: 0.0 to 900.0 s, set at 0.0 s for delivery

(2) Programming function

· Programming method

: WAFER connection

· Program capacity

: 48 WAFERS x 4 loops (max. 192 WAFERS)

A maximum of 48 WAFERS usable in 1 loop

• Kind of wafer : 100 kinds listed in Table 1

(3) Computation cycle

: 200 ms for 4-loop (8PID) control of simplicity PID

(4) Alarm function

Method : Alarm can be displayed and output

through WAFER connection.

• Kinds : Each high/low of PV, SV and MV, PV

change rate alarm, MV change rate

alarm, high/low deviations.

2. Input Signals

Performance under reference condition(23±2°C, 55±10%RH, Power voltage and frequency variation ±1%, free from the effect of external noise) unless otherwise specified.

2-1 Analog input signal

· Number of inputs 8 inputs

· Inpute signal types:

DC voltage, thermocouple (option), resistance bulb (option)

Two thermocouple inputs or two resistance bulb inputs are selectable.

- (1) DC voltage Input range: Selectable among 0 to 5 V DC, 1 to 5 V DC and 0 to 10 V DC Initial set before delivery: 1 to 5 V DC
 - Input accuracy: ±0.1% of input span±1 digit
 - Scaling (Engineering data conversion): Settable within a range from -32767 to

4, 3, 2, 1 or 0 digit below decimal point is selectable.

Initial set before delivery: 0.00% to 100.00%

• Engineering unit: Settable in up to 8 characters

Usable characters: Alphabets numerals, symbols such as +, - ,*,etc.

- Input accuracy guarantee range: -5% to 105% of input range.
- Maximum continuous permissible voltage: ±35 V
- Input resistance: 1 M Ω or more
- Influence by ambient temperature: ±0.1% FS/10°C or less.
- Influence by power supply fluctuation: ±0.1% FS or less.
- · Isolation: Non-isolated from internal circuit.
- In case of current input: Shunt resistor need to be connected to the analog input terminal.

(250 Ω shunt resistor is optional item)

(2) Thermocouple (option)

- Types and measurable ranges:
- * See Table 2.
- Input accuracy: ±0.2% FS ±1 digit [Note]B type: ±5% between 0 to 400°C S and R type: ±1%between 0 to 500°C All type of TC: ±5% under-100°C
- Reference junction compensation error: ±1.0°C (provided measurable range is -50°C and higher)

[Note]Reference junction compensation resistor is connected at external input terminal in case of thermocouple input is ordered.

- Input accuracy guarantee range: -5% to 105% of input range.
- Input resistance: 1 M Ω or more
- Allowable signal source resistance: 100 Ω or less (Zener barrier connection unallowable)

- Influence by signal source resistance: About 0.25 μ V/ Ω
- Influence by ambient temperature: ±0.2% FS/10°C ±1°C or less.
- Influence by power supply fluctuation: ±0.2% FS ±1°C or less
- · Burnout detection: Provided
- Isolation: Isolated from internal circuit.

(3) Resistance bulb (option)

- Types and measurable ranges:
- * See Table 2.
- Input accuracy: ±0.2% FS ±1 digit
- Input accuracy guarantee range: -5% to 105% of input range
- Allowable wiring resistance: 10Ω or less per wire, provided wiring resistance must be equal among 3 wires (Zener barrier connection unallowable)
- •Influence by ambient temperature: ±0.2% FS/10°C or less.
- Influence by power supply fluctuation: ±0.2% FS or less
- Burnout detection: Provided
- Isolation: Isolated from internal circuit.

[Note] FS: full span.

· Sampling period

: 100 ms

2-2 Digital input signal

· Number of inputs

: 10 inputs

· Electrical specifications

: No-voltage contact or transistor contact ON/0 V, OFF/24 V, ON current/about 8

Isolated from the internal circuit by photocoupler. Not isolated between each digital input and output.

- · Contact rating: 30 V DC, 10 mA or more
- · Signal judgment

: No-voltage contact Contact resistance: 200 Ω or less at ON, 100 k Ω or more at OFF

: Transistor contact 1V max at ON.,

leakage current 100µA max. at OFF

3. Output Signals

Performance under reference condition(23±2°C, 55±10%RH, Power voltage and frequency variation ±1%, free from the effect of external noise) unless otherwise specified.

3-1 Analog output signal

- (1) Control output
- · Number of outputs

: Selectable among 1, 2 and 4 outputs

• Output signal : 4 to 20 mA DC

Output accuracy

: ±0.2% FS

· Load resistance

: 600Ω or less

Output accuracy guarantee range

: 2 to 22 mA DC

• Influence by ambient temperature

: ±0.2% FS/10°C or less

· Influence by power supply fluctuation

: ±0.2% FS or less

 Isolation : Non-isolated from internal circuit

(2) Auxiliary analog output

· Number of outputs:

: 4 outputs

• Types of signal: Selectable among 0 to 5 V DC, 1 to 5 V

DC and 0 to 10 V DC

Initial set before delivery: 1 to 5 V DC

Output accuracy

: ±0.1% FS

· Load resistance

: 15 k Ω or more

· Output guarantee range

: 1 to 5 VDC : -12.5% to 112.5% : 0 to 5 VDC : 0% to 112.5% : 0 to 10VDC : 0% to 105%

Influence by power supply fluctuation

: ±0.1% FS or less

Isolation : Non-isolated from internal circuit

3-2 Digital output signal

· Number of outputs

: 10 outputs

· Electrical specifications

: Transistor open collector

1 V max. at ON, 10 μA max at OFF. Isolated from the internal circuit by photocoupler. Not isolated between each digital input and output.

• Output rating : 30 V DC, 100 mA max. (resistive load)

3-3 Fault output signal (terminal symbol FLT)

Number of outputs

: 1 output

Electrical specifications

: Transistor open collector

1 V max. at ON, 10 µA max at OFF. Isolated from the internal circuit by photocoupler. Not isolated between each digital input and output.

• Output rating: 30 V DC, 100 mA max. (resistive load)

4. Display

 Display unit : 16 Colors graphic liquid crystal display,

with CFL back light and contrast adjust

function.

· Contents of display

: Menu

: Loop panel (1, 2, 4 and 8 loops) Bar graph display, digital display, etc.

[Note] The term "loop" hereby indicates the number of control blocks. It does not mean the number of control out puts.

: Tuning screen

: Trend screen (max. 8 screens)

: Alarm and alarm historical screen

: Analog input/output and digital input/ output indication screen

: WAFER connection screen

: Parameter setting screen

5. Setting and Operation

(1) Set point setting method

 Setting key : Up key/down key • Setting speed: About 40 s/FS

· Setting resolution

: 0.05% FS/each key press

(2) Control output operation method

• Operation key: Up key, down key and high-speed key

Operation speed

: About 40 s/FS (usual), about 8 s/FS (high speed)

(3) Operation mode

· Kinds of operation mode

: C, A, and M

[Note] C: Cascade mode (operation according to

remote set point)

A: Auto mode (operation according to the

local set point)

M: Manual mode (control output to be

manually operated by operator)

 Changeover : Balance bumpless changeover from

Auto to Cascade

Balanceless bumpless in other Auto to

Cascade

Balanceless bumpless in other

changeover

[Note] Balance bumpless changeover is a

method where each setting value needs to be balanced by operator him-

self at the time of changeover.

Balanceless bumpless changeover is a method where each setting value is automatically balanced by the controller at

the time of changeover.

(4) Security

 Method : Setting of a password

 Password : Settable in 4 numerals (within 0000 to

Initial set before delivery: 0000

Contents of security

: Inhibition of parameter setting

(5) Other setting items

 Tag name : Settable in up to 8 characters

Usable characters; alphabes, numerals,

symboles such as +, -, *, etc.

6. Power Supply

• Voltage rating: 100 V to 240 V AC/24 V DC

· Allowable range

: 85 V to 264 V AC/20 V to 30 V DC

 Frequency : 47 to 63 Hz

Power consumption

: 60 VA or less (100 V to 240 V AC)

: 30 W or less (24 V DC)

 Power supply output voltage (terminal symbol VP and PC)

: 20V to 30V DC, max. 40mA

7. General performance and characteristics

· Insulation resistance

: 500 V DC, 50 M Ω or more.

· Dielectric strength

: 2,000 V AC for 1 minute between power terminal and ground terminal in case of 100 V to 240 V AC power supply

: 500 V AC for 1 minute between power terminal and ground terminal in case of

24 V DC power supply.

: 500 V AC for 1 minute between signal communication terminals and ground terminal

ullet Rush current : 60 A or less. (100 V AC to 240 V AC

power supply)

• Clock : Set and display year, month, day, hour,

minute, second

accuracy : ± 100 ppm except of time lag shorter than 1 s / power ON / OFF ac-

tion.

Memory backup

: Protection by lithium battery.

(expected battery life is about 2 years

under room temperature)

Parameter and program are stored non-

volatile memory.

8. Operating and storage conditions

Operating temperature

: 0 to 50°C

: 0 to 40°C in case of multiple mounting

(Temperature change rate

: Max. 10°C / h)

· Transport and storage temperature

: -20 to 70°C

(Temprature change rate

: Max. 20°C / h)

Operating humidity

: 5 to 90% RH, condensation unallowable

Transport and storage humidity

: 5 to 95% RH, condensation unallowable

· Operating continuous vibration

: $4.9 \text{ m/s}^2 \text{ or less}$

· Transport and storage shock

: Fall of 60cm max. in packed status

9. Power Failure and restart Function

• Permissible duration of momentary power failure

: 20 ms at 90V AC (100 V to 240 V AC

In the case of 24V DC, it is recommended to avoid power failure problem that system power supply unit with permissible duration of momentary power failure of 20ms or more (PXJ, for powerpals) is used.

example) is used.

• Behavior at power failure detection

: Control stops at detection of power failure.

· Power recovery mode

: Selectable initial start and continuous

10. Self-Diagnosis

· Control and computation circuit failure

: Monitoring with watchdog timer

· Input signal failure

: Voltage/current input Monitoring of range over

: Thermocouple and resistance bulb Monitoring of disconnection

· Control output signal failure

: Monitoring of disconnection by read back check

· Behavior at failure

: FLT is indicated, FLT lamp lights, FLT output signal turns on, control stops and

control output is held.

11. Structure

• Enclosure : Plastic (material: PC-ABS)

• Finish color : Front frame and enclosure both gray

· Flame resistance

: UL94V-0

• Protection : Front face; IP54 (display unit and opera-

tion key)

• External dimensions (W x H x D)

: 72 x 144 x 280 mm : 1.9 kg or less

Mass : 1.9 kgMounting method

: Flush on indoor panel

Vertical mounting as standard

Tilted mounting allowed within back-

ward angle 0° to 45°.



For panel cutout dimension, refer to Panel Cutout Dimensions

External terminal

: Compression terminal type

12. Backup Function (option)

• Method : With backup operation unit

· Number of control outputs

: 1, 2 or 4 outputs selectable.

• Indication : Control output indication of each loop

(mA indication)

• Indicator : 21-segment LED

· Indication changeover

: Changeable to each loop by loop selec-

tion key

Loop No. indicated by 1-digit LED

 Operation key: Control output up, control output down, loop selection

· Operation resolution

: 5%

Backup changeover

: Changeover has been made by the HM (Hard Manual) switch. However, changeover cannot be made when the backup operation unit is faulty.

: In all loops, changeover to the HM mode is blanceless and bumpless.

13. Communications (option)

13-1 RS485 interface-1

Communication behavior

: Slave

Communication protocol

: Modbus® protocol

Physical specification

: EIA RS-485

· Communication method

: Half-duplex, bit serial: Start-stop synchronizing

· Connection form

: Multi-drop

Communication speed

: 19.2 kbps

· Communication distance

: Max. 500 m in total

Number of connectable units

: Max. 31 units

Data length : Fixed to 8 bitsParity : Odd / Even / None

• Stop bit : 1 or 2

• Isolation : Isolated from internal circuit • Terminator : 100 Ω (optional item)

Communication items

: Parameters and process value.

• RS232C / RS485 signal converter (optional item)

: Code symbol: PDZT0001

13-2 RS485 interface-2

Communication behavior

: Master

•Usage : I/O extension

Analog input / output : Max.4 Digital input / output : Max.32

Communication protocol

: OPTO22 interface®

Physical specification

: EIA RS485

Communication method

: Half-duplex, bit serial: Start-stop synchronizing

Communication speed

: 57.6 kbps

• Communication distance

: Max.50m in total

Number of connectable units

: Max.31 units

[Note] Number of units is limited depend on the number of I/O points.

Isolation : Isolated from internal circuitTerminator : 100 Ω (optional item)

Communication item

: Parameters, process values,etc.

· Connectable slave unit

: SNAP I/O series $^{\circledR}$ (OPTO22 corpora-

tion)

14. Soft logic function (option)

[Note] The both of soft logic function and WAFER is not available to operate one time.

· Programming method

: Based on IEC 61131-3 available language; Ladder diagram (LD)

Sequential function chart (SFC) Function block diagram (FBD)

 Programming is to be carried out using the PC based configuration software.
 Programming and editing are not allowed on the controller

Number of steps

: 2k steps of ladder

· Computation cycle

: 200 ms / 2k steps of ladder

15. Memory Card Interface (option)

• Specification : Compact Flash® (Based on CFA)

Compatible memory card

: 5 V flash memory card Capacity 4, 20 and 32 MB

• Application : Process data logging (32 points or less)

Saving period : 1s to 2hData storage capacity

Memory card capacity	Data storge	
4MB	about 180 thousand data	
20MB	about 900 thousand data	
32MB	about 1.35 million data	

[Note] The data of max. 16 points (4 screens) can be storaged at storage time as 1 s.

Format method

: Dependent on this controller

• Data readout : Readout by PC using PCMCIA card slot

· Recommended memory card

 Made by Sandisk corporation
 Sandisk compact Flash memory card is standardized and on the market.

16. Standards under Conformity

(1) General safety

: IEC 1010-1 (1990) EN 61010-1 (1993)

(2) EMC : Emission EN 50081-2 (1994)

Immunity EN 50082-2 (1995)

17. Configuration Software

17-1 Programming loader software

(code symbol: PDZP2001)

This software is installed on the CD-ROM form instruction manual (PDZQ2001) supplied with the main unit. Communication cable (PDZL1001) is optionally available.

- WAFER connection can be entered, edited, uploaded and downloaded.
- Operation parameter can be entered, edited, uploaded and downloaded.

17-2 Soft logic configurator (optional item)

(code symbol: ZOZ*C-KDS-WD2A)

· Programming method

: Based on IEC 61131-3

[Note] The program made by this software cannot be changed by the controller function key.

17-3 Recommended personal computer system

• Hardware : DOS/V machine, Pentium™ 100MHz or

higher

Free hard disk capacity 40MB or more,

memory capacity 32MB or more

Operating system

: Windows 95™/98 SE

17-4 Cable (code symbol: PDZL1001)

Using the configuration software, the configuration file is downloaded via RS232C transmission cable.

Table 1 List of WAFERS

WAFER name	Kinds	Outline
Primary PID	9	Carries out computation on the
		primary loop.
Secondary PID	5	Carries out computation on the
		secondary loop.
Gain schedule	2	Outputs the PID parameter
		corresponding to input 1 according
		to the gain schedule table.
Bit concatevate	8	Outputs digital data as word data to
		an external expansion I/O.
Bit slicing	1	Slices the digital data acquired as
		word data from an external
		expansion I/O into each bit.
Encoder	1	Encodes an input signal into
		a binary code.
Sawtooth wave generator	1	Generates a sawtooth wave with
		a slope entered for each
		cycle time.
BCD	5	Converts BCD data into binary data
		and binary data into BCD data.
Logical operation	6	Carries out AND, OR, NOT, XOR
		and a combination of these logical
		operations.
Arithmetic operation	8	Carries out a combination of
		addition, subtraction, multiplication
		and division.
Temperature/pressure	1	Carries out temperature and
compensation		pressure compensation through use
		of differential pressure, compensated
		pressure, proper temperature.

WAFER name	Kinds	Outline
Linearize	7	Carries out segmented-line approximation with 15-segmented-
		line function.
Program control	4	Time schedule control by step or
		polygonal line approximation with
File files	1	7 segments.
Flip-flop	1	RS flip-flop.
Pulse width integration	1	Adds the change of input at each basic cycle to the previous
		integration value.
Selector	1	Compares two input values, and
		provides High output(Large one),
		Low output(Small one),and result
Oh	1	of judgement on large/small.
Changeover	1	Selects input or output via a switch function. Analog hold circuit also
		provided.
Timer	1	Outputs on-delay,off-delay timer
		signal via start of input signal
		according to timer setting.
Absolute value/sign	1	Carries out absolute value processing
inversion		on input and outputs the result. Also judges the sign(Positive, negative) of
		input value and outputs the result.
Square root extraction	1	Extracts square root of input value
•		and outputs the result.Low input
		cutoff function equipped.
Lead,lag	3	Carries out lead/lag operation on the
		input and outputs the results. Used as analog filter function and
		for various compensations.
Limiter	1	Limits the input within the range of
		high/low limit settings,and outputs
		the result. Also outputs high/low
		limit alarm signal.
Ramp function	2	Outputs signal which changesin ramp from toward target value at
		the set full scale time. There are two
		of these wafersin minute unit and
		hour unit.
Analog averaging	1	Carries out sequential integration of
		input data,calculates the average
		value at each averaging time, and otuputs the result.
Analog integration	1	Integrates the value obtained by
r maiog intogration		multiplying the input data by
		a proportional constant, and outputs
		the result.
Pulse generation	1	Outputs a pulse at the set time
Dead band	1	interval.
Dead Darid	'	Adds dead band compensation to the input and outputs the result.
Pulse No.counter	1	Detects rise of pulse and counts the
		number of pulses.
Pulse No.output	1	Integrates the input signal and
		converts it to number of pulses
		for output.
Decoder	1	Decodes 2-bit pure binary input and outputs it to 4 terminals.
Running average	2	Calculates ranning average of input
g avorago	-	data and outputs the result.
Sample & hold	1	Holds the input value according to
		sample signal(0/1)and continues
Dood time	,	the output.
Dead time	6	Usable for dead time compensation control etc. Data sampling can be
		done in 1 sec or 1 min units.
ON-OFF	1	Outputs ON-OFF signal with
		hysteresis.
	T .	Compares the input and set value
Alarm	1	
		and outputs the judgment result.
Alarm Palse width modurator	1	and outputs the judgment result. Performs output processing in time

 Table 2

 List of Thermocouple and Resistance Bulb Measurable range

Input signal		Input type code	Input range code	Measurable range ⁻ C
Thermocouple	J	01	00	0.0~400.0
	J		01	0.0~800.0
	K		02	0.0~400.0
	K		03	0.0~800.0
	K		04	0.0~1200.0
	R		05	0.0~1600.0
	В		06	0.0~1800.0
	Т		07	-200.0~200.0
	Т		08	-150.0~400.0
	E		09	0.0~800.0
	E		10	-200.0~800.0
	S		11	0.0~1600.0
	N		12	0.0~1300.0
	U		13	-200.0~400.0
	WRe5-26		14	0.0~2300.0
	PLII		15	0.0~1300.0
Resistance bulb	Pt100	00	00	0.0~150.0
			01	0.0~300.0
			02	0.0~500.0
			03	0.0~600.0
			04	-50.0~100.0
			05	-100.0~200.0
			06	-200.0~600.0
			07	-200.0~850.0

SCOPE OF DELIVERY

Controller, panel mounting bracket, instruction manual (depend on code symbols)

Optional Items

Item	Туре	Specification	Available unit
Terminator for communication (100 Ω)	PDZR2001	For compression terminal	1
Shunt resistor (250 Ω)	PDZS2001	For compression terminal	1
Communication cable for configuration software	PDZL1001	Commonly usable cable for configuration software (3m length)	1
Communication cable (Note1) For compression terminal, from PDA to PDA	PDZK4xx1	With compression terminal at both ends	1
For compression terminal, from PDA to PLC	PDZK5xx1	With M3.5 solderless terminal on PLC side	1
For compression terminal, from PDA to PC	PDZK6xx1	9-pin connector on PC side	1
Communication converter	PDZT0001	RS232C / RS485 signal converter	1
Compact Controller M (CC-M) Instruction Manual in book form (in English)	PDZX5001	Instruction manual in book form	1
Compact Controller M (CC-M) Introductory Guide in book form (in English)	PDZX4001	Instruction manual in book form	1
Instruction Manual on CD-ROM (in Japanese and English) (Note2)	PDZQ2001	Instruction manual on CD-ROM	1
Mounting bracket (Note3)	PDZA1001	Improved mounting bracket	1

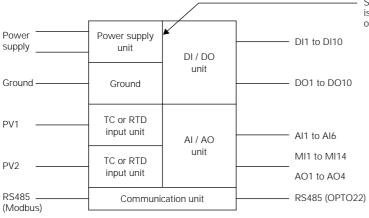
(Note 1) These cables are used for Modbus[®].

Length needs to be specified.

(Note 2) The instruction manual, introductory guide and programming loader software (PDZP2001) are included.

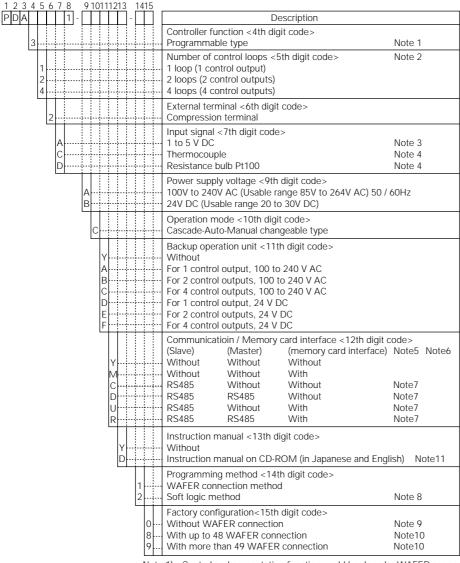
(Note 3) This is the improved mounting bracket adopted from PDA-2. Refer to the outline diagram for shape and dimensions.

Block diagram of electrical isolation



Solid line shows isolation from the other units or circuits.

CODE SYMBOLS



- Note 1) Control and computation function could be done by WAFER connection or soft logic function.
- Note 2) Control loop means the number of control output.
- Note 3) For current input, a shunt resistor is used for conversion into voltage. Shunt resistor is optional item.
- Note 4) Thermocouple and resistance bulb input are opitons.

Allowable up to 2 points.

- Note 5) Communication cable and terminator are optional items.
- Note 6) Recommended maker: Sandisk corporation.
- Note 7) Slave interface is Modbus® protocol and master interface is OPTO22 interface®.
- Note 8) Programming method conforming with IEC61131-3.
 - Optional items Soft logic configurator is necessary for programming.
 - The both of Soft logic function and WAFER is not available to operate one time.
- Note 9) In this case, WAFER connection programming should be made by user.
 - Connection tool (Programming loader) is optional item. When set "2" on the 14th digit code, "0" should be set on the 15th digit code.
- Note 10) WAFER connection specification sheets need to be prepared and submitted by user to Fuji.

Input signal and measurable range initial set before delibvery is as follows.

For specification of voltage input, scale is 0.00 to 100.00%

For specification of thermocouple, K, 0.0 to 400.0°C.

For specification of resistance bulb is 0.0 to 150.0°C.

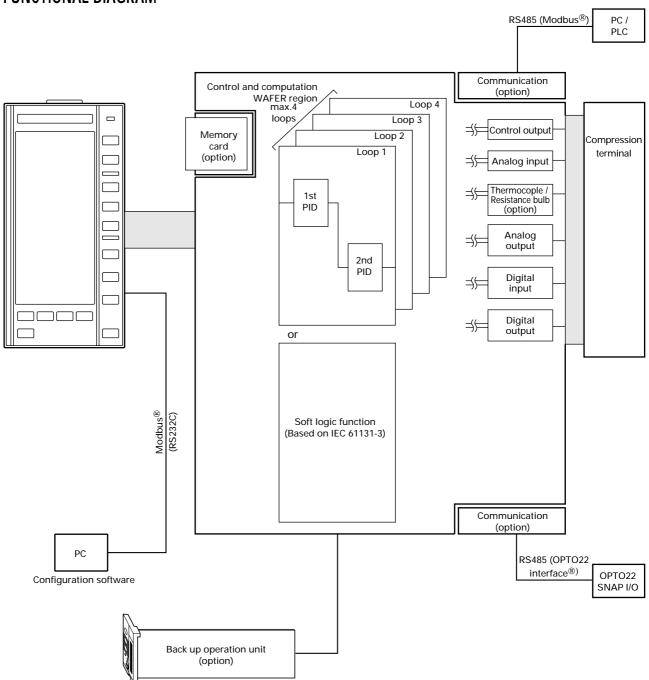
Note 11) Programming Loader (PDZP2001) is included in the CD-ROM.

Communication cable (PDZL1001) is optionally available.

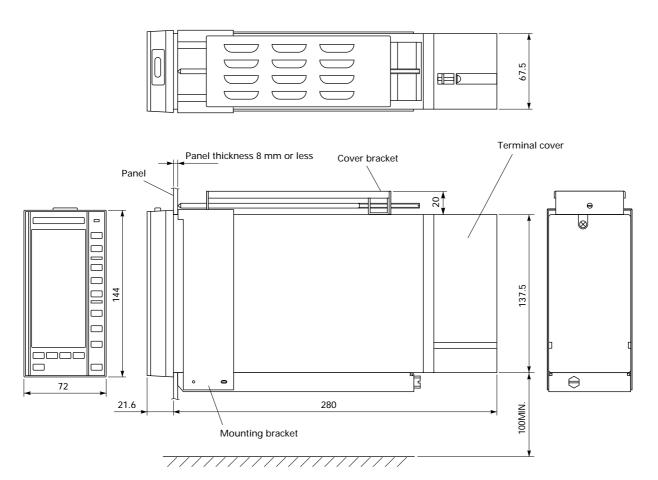
This instruction manual is recorded in PDF format file. To read this manual, Adobe Acrobat Reader is required. Setup program of Acrobat Reader is also

recorded on this CD-ROM.

FUNCTIONAL DIAGRAM

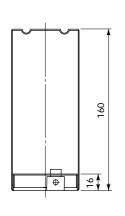


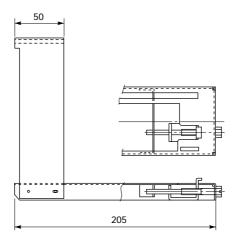
OUTLINE DIAGRAM (Unit: mm)



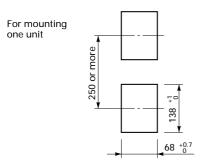
Note) The distance between other instruments and low end of PDA shall be more than 100mm.

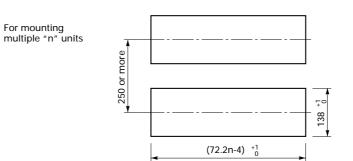
MOUNTING BRACKET





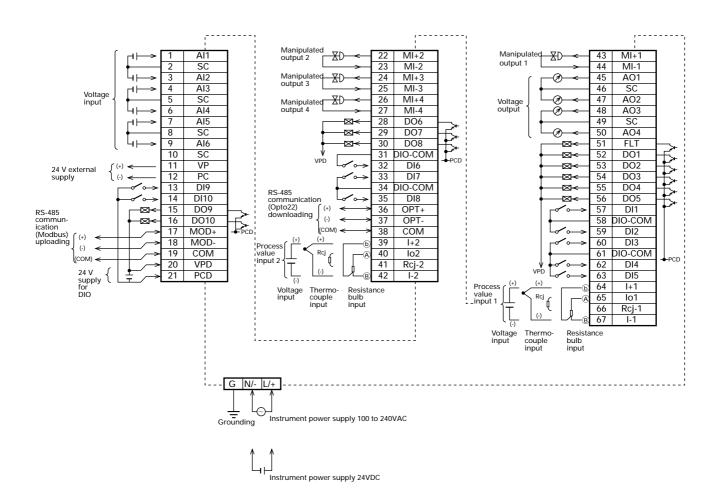
PANEL CUTOUT DIMENSIONS





Number of $n \ge 2$ n; Q'TY

EXTERNAL CONNECTION DIAGRAM



[Note] Windows 95 is the registered trade mark of Microsoft corporation.

[Note] Modbus® is the registered trade mark of Gould Modicon.

[Note] Compact Flash $\!\!^{\rm @}$ is the registered trade mark of Sandisk corporation.

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⚠ Caution on Safety

*Before using this product, be sure to read its instruction manual in advance.

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